# **Electromagnetic and Coupled Field Computations: A Perspective**

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## **Outline**

- Introduction
- Classification of Electromagnetic Field Problems
- Coupled Field Computations
  - Circuit-Field
  - Magnetic-Thermal
  - Magnetic-Structural
- Case Studies
- Concluding Remarks

## Introduction

## **An Overview of EM Applications**

- EM principles form the core of electricity generation, transmission and distribution
- EM, and its computational version, are used to design, test and validate devices across a wide range of sizes from the smallest micro-electro-mechanical (MEMS) devices to the very large transformers and generators

### **Low Frequency Devices:**

- Transformers
- Electric motors
- Power generators
- EM forming and welding
- EM interference/coupling
- Induction heating devices

### **High Frequency Devices:**

- Antennas
- Waveguides and Resonant cavities
- Magnetic storage and imaging systems
- Optoelectronics and photonics
- Microwave circuits and devices
- Plasma devices

## **Need for EM Field Computation**

- Computation of *magnetic fields* is required in all low frequency and high frequency devices for:
  - Evaluation and improvement of performance parameters at the design stage
  - Reliability enhancement
  - Investigative analysis
- Field computation provides a *non-destructive* technique for testing and evaluation
- In order to *optimize* material costs, in the present-day highly global market, an accurate understanding and analysis of the field distribution is necessary

## **Low Frequency Devices: Performance Parameters**

- Inductances and capacitances
- Insulation design for high voltage applications
- Eddy currents
- Forces in windings and current carrying bars
- Torques in rotating machines
- Mechanical stresses / deformations
- Temperature profiles and hot-spots
- Noise level

## **High Frequency Devices: Performance Parameters**

- S parameters
- Power flow/Poynting vector
- Propagation constants
- Characteristic impedance
- Radiation patterns
- Modal field distributions

## **Computational Methods**

- Difference methods:
  - □ Finite difference method (FDM)
  - □ Finite-difference time-domain method (FDTD)
- Variational / Weighted residual approach:
  - □ Finite element method (FEM)
- Integral methods:
  - Method of moments (MoM)
  - Boundary element method (BEM)
  - □ Charge simulation method (CSM)

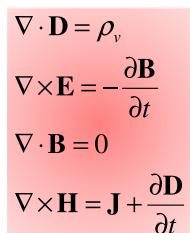
### **Finite Element Method**

- The method has emerged as the forerunner among all the numerical techniques
  - Geometrical complexities can be handled in better ways using FEM
  - Anisotropic, non-uniform and non-linear media can be incorporated
  - Availability of several commercial softwares makes the applicability to real-life problems easier
  - □ Finite element method can also be used in solving problems involving coupling of electromagnetic fields with circuits and/or other physical fields

# Classification of Electromagnetic Field Problems

## **Basic Governing Equations**

Maxwell's equations: -



 $\mathbf{D} = \boldsymbol{\varepsilon} \mathbf{E}$ 

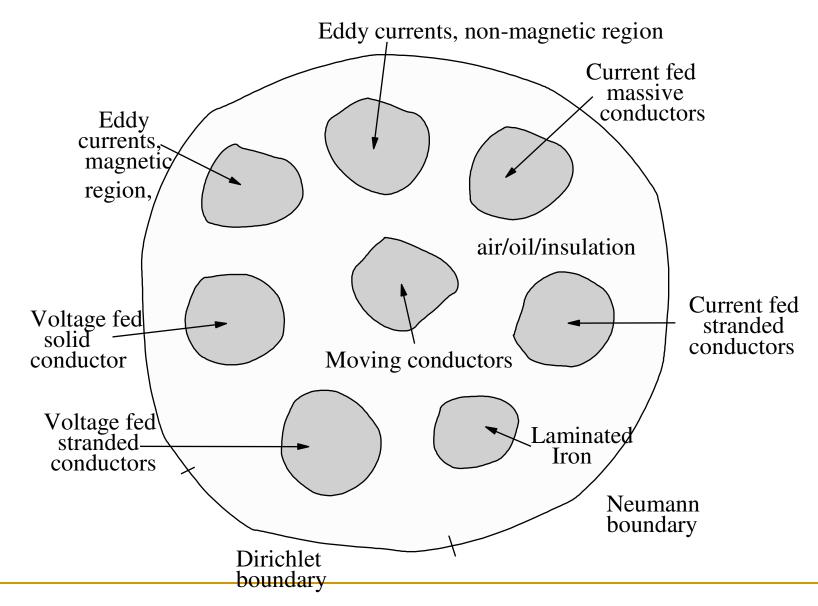
 $\mathbf{B} = \mu \mathbf{H}$ 

 $J = \sigma E$ 

■ Continuity equation: - 
$$\nabla \cdot \mathbf{J} = -\frac{\partial \rho_{v}}{\partial t}$$

Lorentz force equation: - 
$$\mathbf{F} = Q(\mathbf{E} + v \times \mathbf{B})$$

## Typical entities and problem types: Low frequency



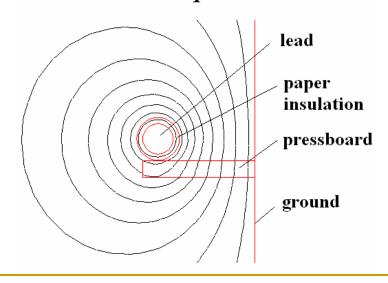
## **Classification of Electromagnetic Field Problems**

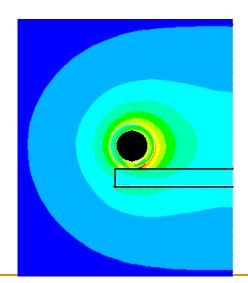
### Electrostatics:

 Analysis of the electric field in capacitive or dielectric systems

$$\varepsilon_x \frac{d^2V}{dx^2} + \varepsilon_y \frac{d^2V}{dy^2} = -\rho_V$$

 Computation of electric field, capacitance, electrostatic forces and torques, etc.



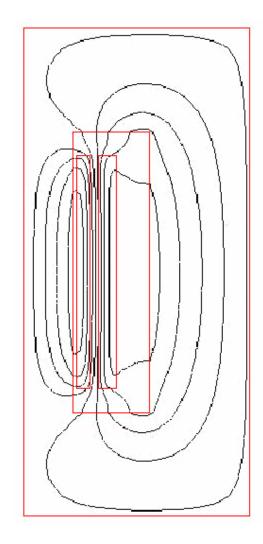


## Magnetostatics:

 This analysis type is used to analyze magnetic field produced by direct electric current, permanent magnet or applied magnetic field

$$\frac{1}{\mu_x} \frac{d^2 \mathbf{A}}{dx^2} + \frac{1}{\mu_y} \frac{d^2 \mathbf{A}}{dy^2} = -\mathbf{J}_o$$

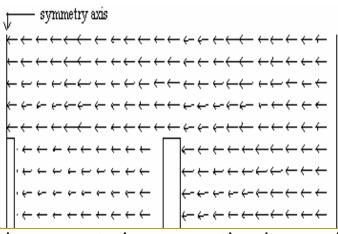
□ The static analysis is used to compute parameters such as magnetic flux, self and mutual inductances, forces, torques, etc.

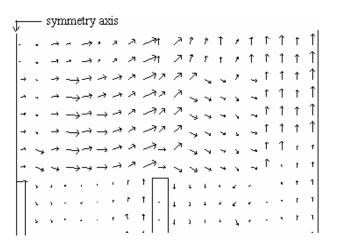


### Time-harmonic: Diffusion Equation

- Harmonic analysis is used for sinusoidal excitations and linear materials
- The analysis can be carried out for a single frequency or a range of frequencies to compute eddy currents, stray losses, skin effect and proximity effect

$$\frac{1}{\mu_x} \frac{d^2 \mathbf{A}}{dx^2} + \frac{1}{\mu_v} \frac{d^2 \mathbf{A}}{dy^2} + \frac{1}{\mu_z} \frac{d^2 \mathbf{A}}{dy^2} = \sigma (\nabla V + j\omega \mathbf{A})$$





Eddy currents in magnetic clamp plate

Eddy currents in non-magnetic clamp plate

## Time-harmonic: Wave Equation

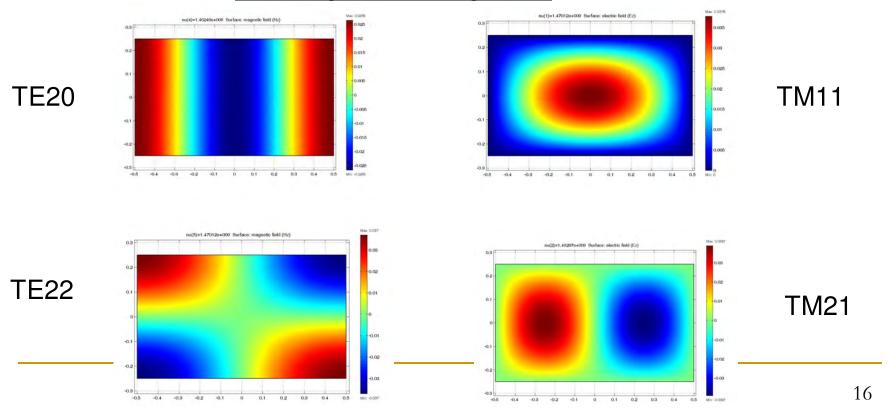
□ The wave equations for time harmonic electric and magnetic fields with angular frequency ω are:

$$\nabla^{2}\mathbf{E} + \omega^{2}\mu\varepsilon\mathbf{E} = 0$$

$$\nabla^{2}\mathbf{H} + \omega^{2}\mu\varepsilon\mathbf{H} = 0$$

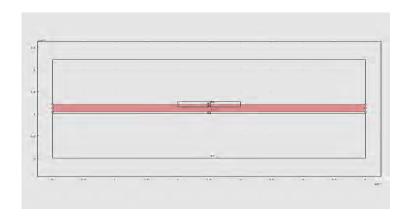
$$\nabla^{2} \equiv \frac{\partial^{2}}{\partial x^{2}} + \frac{\partial^{2}}{\partial y^{2}} + \frac{\partial^{2}}{\partial z^{2}}$$

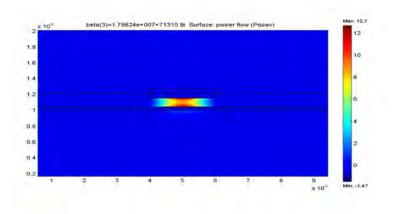
### Rectangular Waveguides



## Eigenvalue FEM analysis of a plasmonic waveguide

- Photonic circuits of nanoscale dimensons: A potential research area
- These could form harmonizing links between nano-scaled electron devices and micro-scaled optical devices





- FEM analysis\*: Metal-dielectric-slotted metal structure
- A good confinement and a propagation length of 10 μm is observed

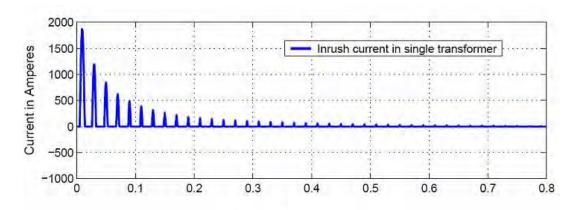
<sup>\*</sup> Courtesy: Ms. Padmaja, Research Scholar, EE Dept, IIT Bombay

#### Transient:

 Transient magnetic analysis is a technique for calculating magnetic fields that vary over time, such as those caused by surges in voltage or current or pulsed external fields

$$\frac{1}{\mu} \frac{d^2 \mathbf{A}}{dx^2} + \frac{1}{\mu} \frac{d^2 \mathbf{A}}{dy^2} = \sigma \left( \nabla V + \frac{\partial \mathbf{A}}{\partial t} \right)$$

 Performance parameters such as inrush current, eddy currents and forces can be computed when electrical machines are subjected to transient stresses.



### Potentials Used in Computational Electromagnetics

### **Electric scalar potential** (V):

- Used in electrostatic formulations: Insulation design in high voltage equipment
- Analysis of frequency-dependent performance of dielectrics

$$\nabla \cdot \left( \mathbf{J} + \frac{\partial \mathbf{D}}{\partial t} \right) = 0$$

If the effects of magnetic field can be neglected,

$$\nabla \times \mathbf{E} = 0 \implies \mathbf{E} = -\nabla V$$

$$-\nabla \cdot (\boldsymbol{\sigma} \nabla V) - \nabla \cdot \left( \frac{\partial}{\partial t} (\boldsymbol{\varepsilon} \nabla V) \right) = 0$$

$$-\nabla \cdot ((\sigma + j\omega\varepsilon)\nabla V) = 0$$

$$-\nabla \cdot \left( \left( \sigma_{eff} + j\omega \varepsilon' \right) \nabla V \right) = 0 \qquad \sigma_{eff} = \sigma + \omega \varepsilon'' = \sigma + \omega \varepsilon' \tan \delta$$

### Magnetic vector potential (A):

- □ In the case of 2-D models, the formulation based on magnetic vector potential (MVP) is generally used
  - The number of unknowns at any point reduce from 2 (Bx, By) to one (Az), with the current in z-direction

$$\varphi = \iint_{S} \mathbf{B} \cdot d\mathbf{S} = \oint_{L} \mathbf{A} \cdot d\mathbf{I}$$
Flux passing through any two points 1 and  $2 \to \phi = A_1 - A_2$  (2-D case)

- However in 3-D models, the MVP formulation has three degrees of freedom per node, Ax, Ay and Az, making it computationally unattractive
- MVP formulation can be used for static, time-harmonic or transient magnetic analyses
- □ If there are eddy current regions, additionally the electric scalar potential needs to be considered (**A**-V, **A** formulation)

### • Magnetic scalar potential $(\Omega)$ :

- □ In 3-D problems, A has three unknowns at every point
- The scalar potential formulation has only one degree of freedom per node
- □ The magnetic scalar potential based formulation is therefore suitable for 3-D magnetostatic problems
- □ The scalar potential cannot be used for current carrying regions and/or in any part which surrounds such regions
- Reduced scalar potential is used to circumvent above restrictions
- Reduced Scalar Potential ( $\Omega_r$ ) or Total Scalar Potential ( $\Omega$ ) is selected as variable depending on presence and absence of current carrying domains, respectively: Hybrid formulation

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### Electric Vector Potential (T)

Used for solving eddy current problems

$$\nabla \times \mathbf{T} = \mathbf{J}$$

$$\mathbf{H} - \mathbf{T} = -\nabla \Omega \qquad \Rightarrow \qquad \mathbf{H} = \mathbf{T} - \nabla \Omega$$

- □ Compare with:  $\mathbf{E} = -\partial \mathbf{A}/\partial t \nabla V$ .
- □ **T** represents induced eddy currents like the term  $-\partial \mathbf{A}/\partial t$  does in the **A**-based formulation
- □ The formulation is advantageous for the analysis of eddy currents in laminated structures

### Nodal Vs Vector (Edge) Elements

- Nodal formulation: Popularly used for low frequency computations
  - Simpler and easy to implement
  - 'Scalar' FEM
- Edge elements: Better suited for high frequency computations
  - Degrees of freedom are associated with edges
  - Continuity of tangential components of field vectors is ensured
  - Spurious modes/solutions are avoided as the divergence condition is satisfied
  - They are better in handling singularities

# **Coupled Field Computations**

## **About Coupled Fields**

### Classification:

- Weakly coupled
- Strongly coupled

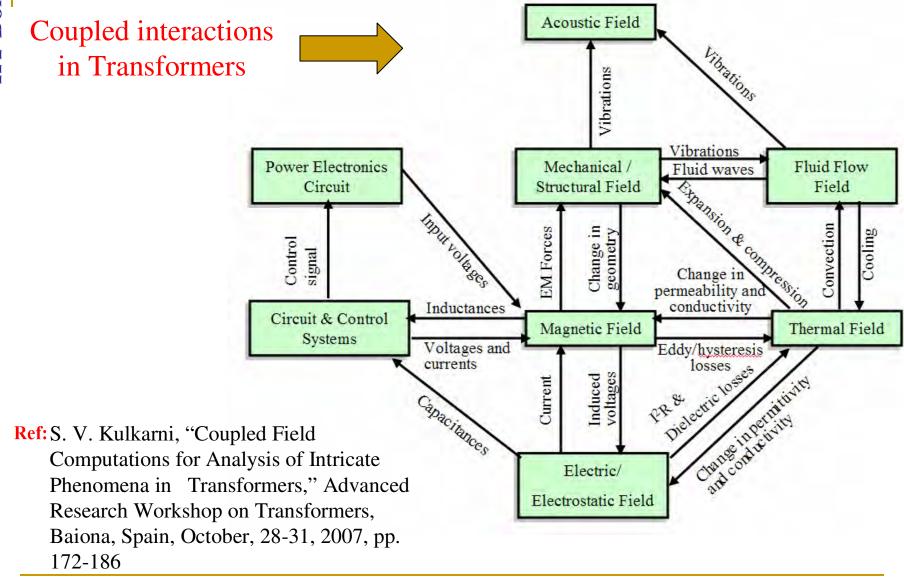
### Weak or indirect coupling:

- Solution of one field acts as load to another field
- □ It is flexible, modular and easy approach

### Strong or direct coupling:

- Coupled field equations are solved simultaneously
- The approach is used when field interactions are highly nonlinear and the coupled fields have comparable time constants.

## **Coupled Systems:** Real-Life Design Problems



# **Coupled Field Computations**

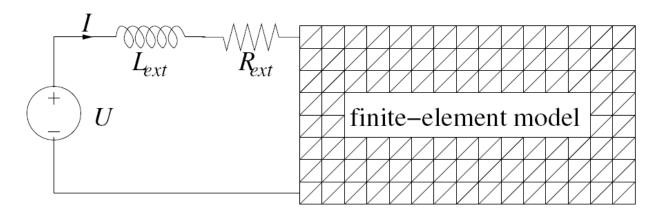
Circuit - Field

## **Field-Circuit Coupling**

Electromagnetic model:

$$\frac{\partial}{\partial x} \left( \upsilon \frac{\partial A_z}{\partial x} \right) + \frac{\partial}{\partial y} \left( \upsilon \frac{\partial A_z}{\partial y} \right) = -J_z$$

Circuit coupling:



## **Conductor Models**

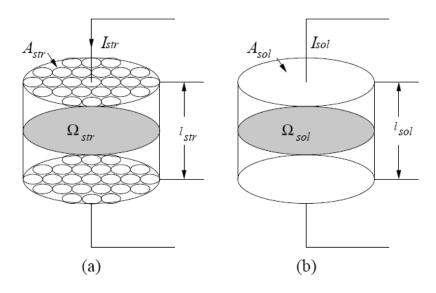


Figure 3.2: (a) Stranded (b) solid conductor models

### Stranded conductor:

$$J_{str} = \frac{N_{str}I_{str}}{A_{str}}$$

Solid (massive) conductor:

$$J_{sol} = \sigma \frac{V_{sol}}{l_{sol}} - \sigma \frac{\partial A_z}{\partial t}$$

## **Field-Circuit Coupling**

### FEM formulation for stranded conductor

$$\frac{\partial}{\partial x} \left( \frac{1}{\mu} \frac{\partial A_z}{\partial x} \right) + \frac{\partial}{\partial y} \left( \frac{1}{\mu} \frac{\partial A_z}{\partial y} \right) = -J_z \qquad \qquad J_z = \frac{N_{str} I_{str}}{A_{str}}$$

Finite element discretization leads to:

$$\left[\mathbf{K}\right]\left\{\mathbf{A}\right\} + \left[\mathbf{P}\right]\left\{\mathbf{I}\right\} = 0$$

where,

$$\left[\mathbf{K}\right] = \sum_{\Omega} \upsilon \iint_{\Delta_{\mathbf{e}}} \left( \frac{\partial N_{\mathbf{e}}^{T}}{\partial x} \frac{\partial N_{\mathbf{e}}}{\partial x} + \frac{\partial N_{\mathbf{e}}^{T}}{\partial y} \frac{\partial N_{\mathbf{e}}}{\partial y} \right) dx dy$$

$$[\mathbf{P}] = \sum_{\Omega} \frac{N_{str}}{A_{str}} \iint_{\Delta_e} N_e^T \ dxdy$$

## **Field-Circuit Coupling**

Circuit equations can be written as:

$$\{\mathbf{U}\} = \left\{\frac{d\mathbf{\Phi}}{dt}\right\} + \left[\mathbf{R}\right]\left\{\mathbf{I}\right\} + \left[\mathbf{L}\right]\left\{\frac{d\mathbf{I}}{dt}\right\}$$

$$\frac{d\phi}{dt} = \frac{L_{str}}{A_{str}} \int_{\Omega} \frac{\partial A_{z}}{\partial t} d\Omega$$

$$\{\mathbf{U}\} = \left[\mathbf{G}\right] \left\{ \frac{d\mathbf{A}}{dt} \right\} + \left[\mathbf{R}\right] \left\{\mathbf{I}\right\} + \left[\mathbf{L}\right] \left\{ \frac{d\mathbf{I}}{dt} \right\}$$

Global system of equations is given as:

$$\begin{bmatrix} \begin{bmatrix} \mathbf{0} \end{bmatrix} & \begin{bmatrix} \mathbf{0} \end{bmatrix} \\ \begin{bmatrix} \mathbf{G} \end{bmatrix} & \begin{bmatrix} \mathbf{I} \end{bmatrix} \end{bmatrix} + \begin{bmatrix} \begin{bmatrix} \mathbf{K} \end{bmatrix} & \begin{bmatrix} \mathbf{P} \end{bmatrix} \\ \begin{bmatrix} \mathbf{0} \end{bmatrix} & \begin{bmatrix} \mathbf{A} \end{bmatrix} \end{bmatrix} = \begin{bmatrix} \mathbf{0} \\ \mathbf{I} \end{bmatrix}$$

## **Coupled Field Formulations: Solid Conductor**

Field Equation:

$$\frac{\partial}{\partial x} \left( \frac{1}{\mu} \frac{\partial A_z}{\partial x} \right) + \frac{\partial}{\partial y} \left( \frac{1}{\mu} \frac{\partial A_z}{\partial y} \right) = -\sigma \frac{V}{l_{sol}} + \sigma \frac{\partial A_z}{\partial t}$$

Internal Current Equation:  $I = G_{sol} V - \int_{\Omega} \sigma \frac{dA_z}{\Delta t} d\Omega$ 

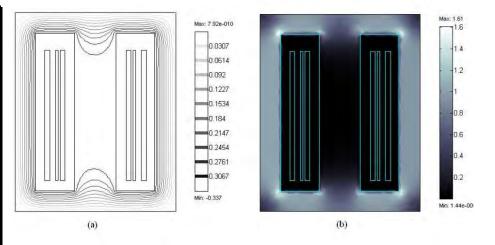
Circuit Equation: 
$$\{U\} = \{V\} + [R]\{I\} + [L]\left\{\frac{dI}{dt}\right\}$$

$$\begin{bmatrix} \begin{bmatrix} \mathbf{Q} \end{bmatrix} & \begin{bmatrix} \mathbf{0} \end{bmatrix} & \begin{bmatrix} \mathbf{0} \end{bmatrix} \\ \begin{bmatrix} \mathbf{B} \end{bmatrix}^T & \begin{bmatrix} \mathbf{0} \end{bmatrix} & \begin{bmatrix} \mathbf{0} \end{bmatrix} \\ \begin{bmatrix} \mathbf{0} \end{bmatrix} & \begin{bmatrix} \mathbf{0} \end{bmatrix} \end{bmatrix} \begin{bmatrix} \mathbf{A} \\ \mathbf{V} \end{bmatrix} + \begin{bmatrix} \mathbf{0} \end{bmatrix} & \begin{bmatrix} \mathbf{S} \end{bmatrix} & \begin{bmatrix} \mathbf{P} \end{bmatrix} \\ \begin{bmatrix} \mathbf{0} \end{bmatrix} & \begin{bmatrix} \mathbf{S} \end{bmatrix} & \begin{bmatrix} \mathbf{P} \end{bmatrix} \end{bmatrix} \begin{bmatrix} \mathbf{A} \\ \mathbf{V} \end{bmatrix} = \begin{bmatrix} \mathbf{0} \\ \mathbf{0} \end{bmatrix} \begin{bmatrix} \mathbf{0} \end{bmatrix} \begin{bmatrix} \mathbf{A} \end{bmatrix} \begin{bmatrix} \mathbf{A}$$

## 1. Half-Turn Effect

### Single-phase three-limb transformer

	Measured	FEM
Flux density in end limbs (T)	1.04	0.93
Extra core loss due to the half- turn effect (kW)	4.2	3.9



(a) Flux lines (b) flux density plots with half-turn

### Three-phase five-limb transformer

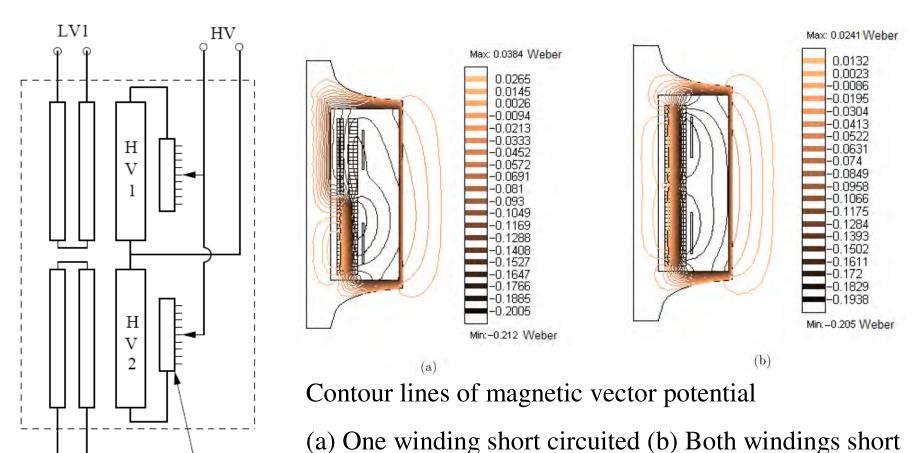
	Flux density (T) for unbalanced currents in windings			
	Balanced	10% unbalance	20% unbalance	
Without half-turn	0.02	0.035	0.045	
With half-turn	0.04	0.108	0.25	

Ref: G. B. Kumbhar, S. V. Kulkarni, and V. S. Joshi, "Analysis of half-turn effect in power transformers using nonlinear-transient FE formulation," IEEE Trans. Power Delivery, vol. 22, no. 1, Jan 2007, pp. 195-200.

LV2

Tap

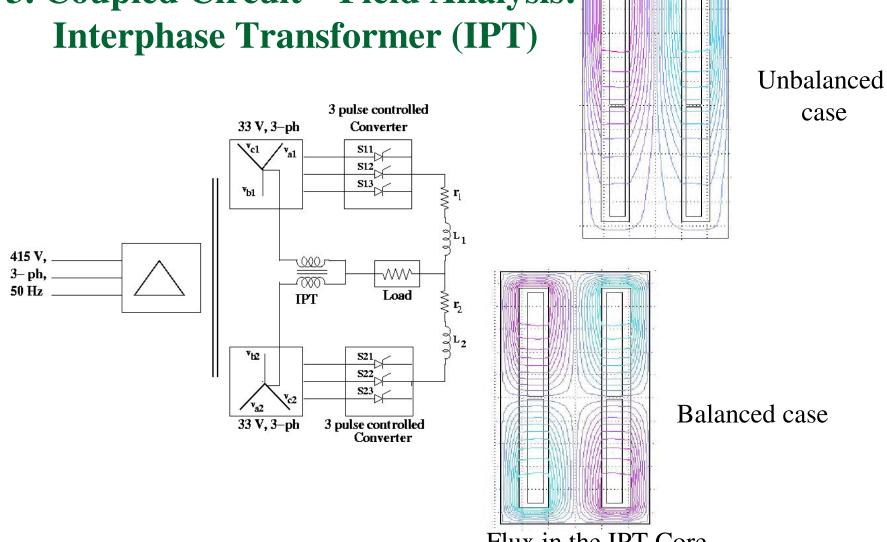
## 2. Forces in Split-Winding Transformer



Ref: G. B. Kumbhar, S. V. Kulkarni, and V. S. Joshi, "Analysis of short circuit performance of split-winding transformer using coupled field-circuit approach," *IEEE Trans. Power Delivery*, vol. 22, no. 2, April 2007, pp. 936-943.

circuited

## 3. Coupled Circuit – Field Analysis: **Interphase Transformer (IPT)**



Flux in the IPT Core

Ref: R. S. Bhide, G. B. Kumbhar, S. V. Kulkarni, and J. P. Koria, "Coupled circuit-field formulation for analysis of parallel operation of converters with interphase transformer," Electric Power Systems Research. Vol. 78, Issue 1, January 2008, pp. 158-164.

# **Coupled Field Computations**

**Magnetic – Thermal** 

#### **Magnetic-Thermal Coupling**

 The 2-D transient magnetic and thermal equations are

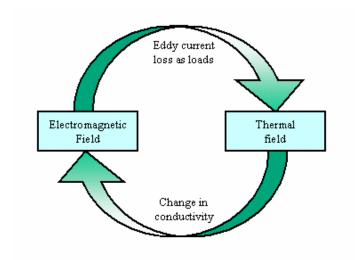
$$\nabla \cdot \left(\frac{1}{\mu} \nabla (A_z)\right) = -\sigma (T) \frac{V}{I} + \sigma (T) \frac{\partial A_z}{\partial t}$$

$$\nabla \cdot (k \nabla (T)) = -q(A_z, T) + mc \frac{\partial T}{\partial t}$$

These are coupled by the following relations

$$\sigma(T) = \frac{\sigma_{ref}}{\left(1 + \alpha(T - T_{ref})\right)}$$

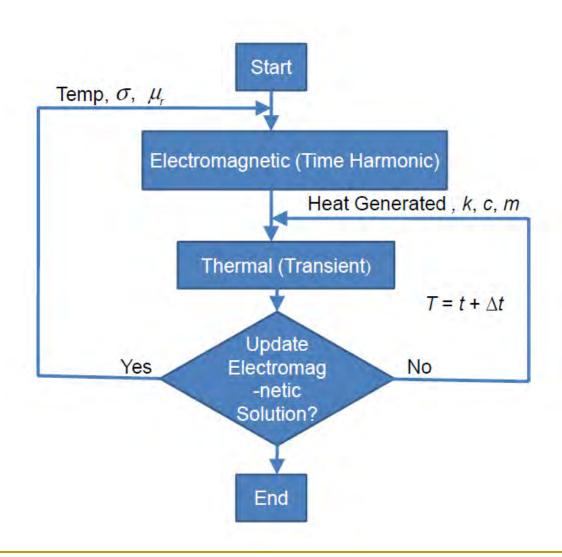
$$q(A_z, T) = \frac{1}{\Omega_e} \int_{\Omega_e} \sigma(T) \left(-\frac{V}{L} + \frac{\partial A_z}{\partial t}\right)^2 d\Omega$$



Convection boundary conditions

$$k \nabla (T) \cdot n + h_c (T - T_a) = 0$$

### **Magnetic-Thermal Coupling**



#### **Formulation**

Magnetic equations for solid conductors (g=-V/L)

$$\frac{\partial}{\partial x} \left( \frac{1}{\mu_0} \frac{\partial A_z}{\partial x} \right) + \frac{\partial}{\partial y} \left( \frac{1}{\mu_0} \frac{\partial A_z}{\partial y} \right) = \sigma \left( g + j \omega A_z \right)$$

$$I = \int_{\Omega_c} \sigma \left( g + j \omega A_z \right) d\Omega_c$$

In matrix form

$$\begin{bmatrix} \mathbf{K} + j\omega \mathbf{V} & \mathbf{W} \\ j\omega \mathbf{W}^T & \mathbf{G} \end{bmatrix} \begin{bmatrix} \mathbf{A} \\ \mathbf{g} \end{bmatrix} = \begin{bmatrix} 0 \\ \mathbf{I} \end{bmatrix}$$

Elemental loss

$$Q_{e} = \int_{\Omega_{e}} \sigma \left(g + j\omega A_{z}\right) \left(g + j\omega A_{z}\right)^{*} d\Omega_{e}$$

$$\left[\mathbf{K}\right] = \sum_{\Omega} \upsilon \iint_{\Delta_{\mathbf{e}}} \left( \frac{\partial N_{\mathbf{e}}^{\mathsf{T}}}{\partial x} \frac{\partial N_{\mathbf{e}}}{\partial x} + \frac{\partial N_{\mathbf{e}}^{\mathsf{T}}}{\partial y} \frac{\partial N_{\mathbf{e}}}{\partial y} \right) dx dy$$

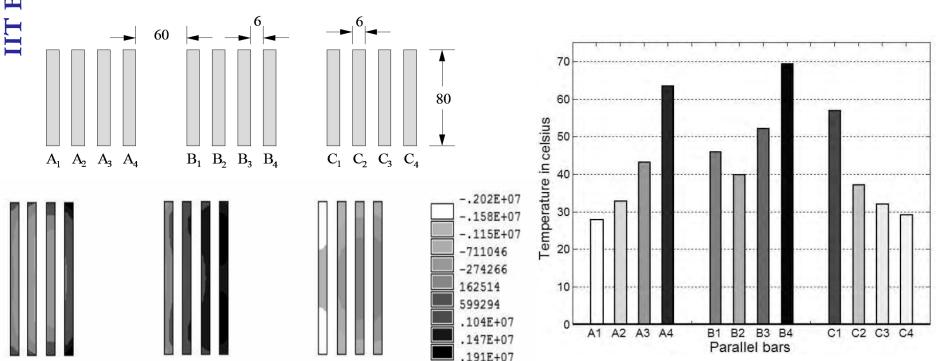
$$[\mathbf{V}] = \sum_{\Omega} \sigma \iint_{\Delta_e} N_e^{\mathsf{T}} N_e \, dx \, dy$$

$$[\mathbf{W}] = \sum_{\Omega} \sigma \iint_{\Delta_{\mathbf{e}}} N_{\mathbf{e}}^{\mathsf{T}} \, dxdy$$

**G'** is the diagonal matrix of the conductance of the bars

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#### 1. High Current Terminations

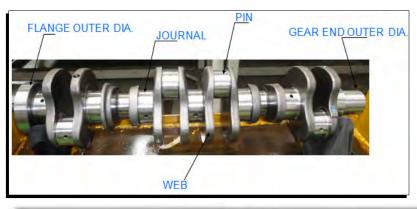


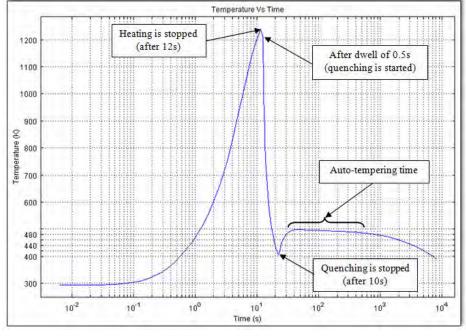
**Unequal Current Distribution** 

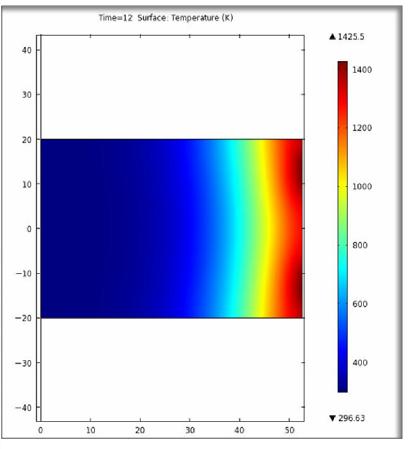
Non-uniform Temperature distribution

Ref: G.B. Kumbhar, S.V. Kulkarni, R. Escarela-Perez, and E. Campero-Littlewood, "Applications of coupled field formulations to electrical machinery," COMPEL Journal, Vol. 26, Issue 2, 2007, pp. 489-523.

#### 2. Induction Hardening







**Temperature distribution** 

**Auto-tempering process** 

Ref: Sanjay Patil, Simulation of auto-tempering of induction hardened crackshaft steel, M.Tech Thesis, MEMS Dept, IIT Bombay, 2011.

## **Coupled Field Computations**

**Magnetic – Structural** 

## Coupled Field Formulations: Magnetic-Structural

#### Coupled Equations:

$$\begin{bmatrix} \begin{bmatrix} K \end{bmatrix} & \begin{bmatrix} C \end{bmatrix} \\ \begin{bmatrix} N \end{bmatrix} & \begin{bmatrix} M \end{bmatrix} \end{bmatrix} \begin{cases} \{A\} \\ \{X\} \} \end{cases} = \begin{cases} \{J\} \\ \{F_{ext}\} \}$$

K and M are magnetic and mechanical stiffness matrices respectively. A and X are nodal values of magnetic vector potential and displacements.

#### **■**The formulation with suitable modifications can be used for:

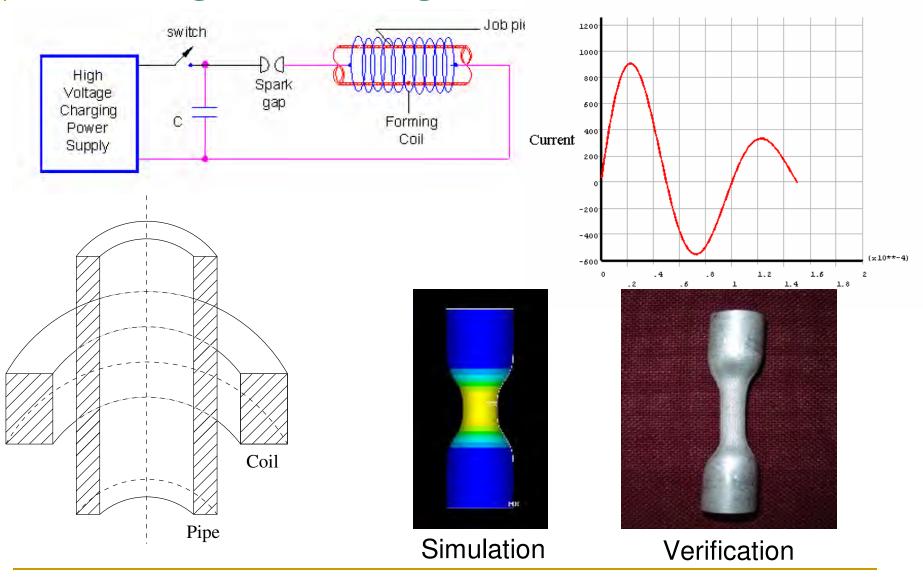
- Analysis of core noise: Magnetostriction phenomenon
- Computation of noise due to winding vibrations (J x B Force)
- Analysis of winding deformations due to short circuit forces
- Design of high current carrying bars in large rectifier and furnace duty applications

- [N] and [C] are the coupling matrices, and  $\{J\}$  and  $\{F_{ext}\}$  are the column vectors representing the magnetic and mechanical source terms, respectively.
- -The term [N] represents the effect of magnetic parameters on mechanical displacements, whereas [C] represents the effect of mechanical displacements on magnetic parameters.
- It can be proved that the total magnetic force  $(\mathbf{F}_{mag})$  can be represented by  $-[N]\{\mathbf{A}\}$
- -If the effects of displacements on magnetic fields are not appreciable, [C] can be neglected and the magnetic forces affecting displacements can be added to the mechanical (external) forces:

$$\begin{bmatrix} \begin{bmatrix} K \end{bmatrix} & \begin{bmatrix} 0 \end{bmatrix} \\ \begin{bmatrix} 0 \end{bmatrix} & \begin{bmatrix} M \end{bmatrix} \end{bmatrix} \begin{cases} \mathbf{A} \\ \mathbf{X} \end{cases} = \begin{cases} \mathbf{J} \\ \left\{ \mathbf{F}_{ext} + \mathbf{F}_{mag} \right\} \end{cases}$$

-The magnetostriction phenomenon can also be considered in a weakly coupled scheme by adding the corresponding vector  $\{\mathbf{F}ms\}$  to the force terms

## **Electromagnetic Forming**



# **Concluding Remarks**

#### **Current and Emerging Trends**

- Competence in 3-D analysis is essential
- Coupled field computations (circuit-field, magnetic-thermal, magnetic-structural) will be increasingly used
- Coupled EM-thermal-structural analysis is not uncommon these days
- Hybrid numerical techniques are being used for complex problems
- Other trends
  - □ Parallel computing
  - Real time FEM
  - Meshless methods
  - Wavelet based FEM

# Thank You!